



Click [here](#) for the 3D model.

Dimensions

Case Code	40
L	7.9mm +/-0.38mm
W	12.2mm +/-0.4mm
H	8.9mm +/-0.38mm
S	1.4mm +/-0.38mm
F	10.5mm +/-0.4mm
K	6.6mm +/-0.38mm

Packaging Specifications

Packaging	T&R, 178mm
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General Information

Series	TSP
Dielectric	Polymer Tantalum
Style	Stacked Chip
Description	SMD, Polymer, KO, Stacks, High Reliability
Features	High Reliability
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
SCIP Number	30e82d35-b509-48ec-8c77-2d5ec01b3abc
Termination	Solder Coated
Termination (Stack)	Solder Coated
AEC-Q200	No

Specifications

Capacitance	270 uF
Capacitance Tolerance	20%
Voltage DC	40 VDC (105C), 26.8 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	105°C
Dissipation Factor	10% 120Hz 25C
Failure Rate	N/A
Resistance	15 mOhms (100kHz 25C)
Leakage Current	1080 uA (5min 25°C)